

2.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

PowerDI[®]123

DFLS220L

Features

- Guard Ring Die Construction for Transient Protection ٠
- Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- High Current Capability and Low Forward Voltage Drop
- Lead Free Finish, RoHS Compliant (Note 5)
- "Green" Molding Compound (No Br, Sb)

Mechanical Data

- Case: PowerDI[®]123
- Plastic Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed Over Copper leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.01 grams (approximate)



Top View

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

| Characteristic | Symbol | Value | Unit |
|---|--|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 20 | V |
| RMS Reverse Voltage | V _{R(RMS)} | 14 | V |
| Average Forward Current | I _{F(AV)} | 2.0 | А |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I _{FSM} | 40 | А |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-------------------|-------------|------|
| Power Dissipation (Note 1) | PD | 1.67 | W |
| Power Dissipation (Note 2) | PD | 556 | mW |
| Thermal Resistance Junction to Ambient (Note 1) | R ₀ JA | 60 | °C/W |
| Thermal Resistance Junction to Ambient (Note 2) | $R_{	heta JA}$ | 180 | °C/W |
| Thermal Resistance Junction to Soldering (Note 3) | R _{0JS} | 10 | °C/W |
| Operating Temperature Range | TJ | -55 to +125 | °C |
| Storage Temperature Range | T _{STG} | -55 to +150 | ۵° |

Electrical Characteristics @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|--------------------|-----|---------------|--------------|------|---|
| Reverse Breakdown Voltage (Note 4) | V _{(BR)R} | 20 | _ | _ | V | I _R = 1.0mA |
| Forward Voltage | V _F | | 0.32 0.375 | 0.36 0.42 | V | I _F = 1.0A I _F = 2.0A |
| Leakage Current (Note 4) | I _R | | 0.26 | 1.0 | mA | V _R = 5V, T _A = 25°C V _R = 20V, T _A = 25°C |
| Total Capacitance | CT | | 75 | _ | pF | V _R = 10V, f = 1.0MHz |

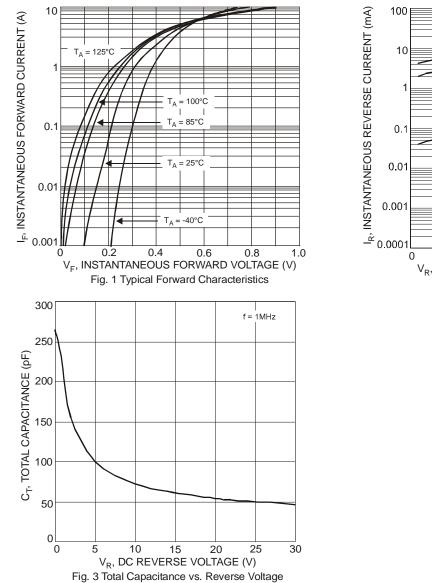
1. Part mounted on 50.8mm X 50.8mm GETEK board with 25.4mm X 25.4mm copper pad, 25% anode, 75% cathode. T_A = 25°C. Notes:

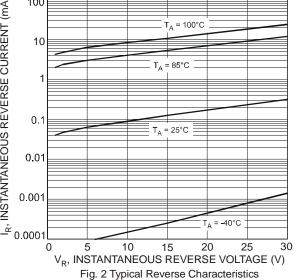
2. Part mounted on FR-4 board with 1.8mm X 2.5mm cathode and 1.8mm X 1.2mm anode, 1 oz. copper pads. T_A = 25°C.

3. Theoretical $R_{0,S}$ calculated from the top center of the die straight down to the PCB/cathode tab solder junction.

Short duration pulse test used to minimize self-heating effect.
EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.







Ordering Information (Note 6)

| Part Number | Case | Packaging |
|-------------|--------------------------|------------------|
| DFLS220L-7 | PowerDI [®] 123 | 3000/Tape & Reel |

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



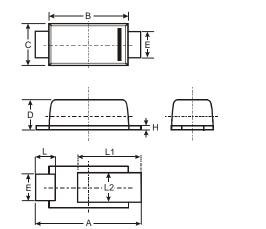
F02A = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)

| Date Code K | ley | | | | | | | | | | | |
|-------------|------|------|-------|------|-------|------|------|------|------|------|------|------|
| Year | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 | 2015 |
| Code | R | S | Т | U | V | W | Х | Y | Z | A | В | С |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| | Jan | IED | IVIAI | -трі | Iviay | Juli | Jui | Aug | Jeh | 001 | - | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |

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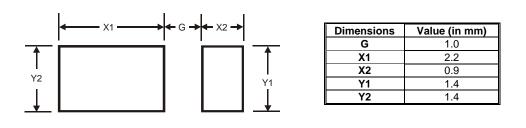


Package Outline Dimensions



| PowerDI [®] 123 | | | | | | | |
|--------------------------|------|------|------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 3.50 | 3.90 | 3.70 | | | | |
| В | 2.60 | 3.00 | 2.80 | | | | |
| С | 1.63 | 1.93 | 1.78 | | | | |
| D | 0.93 | 1.00 | 0.98 | | | | |
| Ε | 0.85 | 1.25 | 1.00 | | | | |
| Н | 0.15 | 0.25 | 0.20 | | | | |
| L | 0.55 | 0.75 | 0.65 | | | | |
| L1 | 1.80 | 2.20 | 2.00 | | | | |
| L2 | 0.95 | 1.25 | 1.10 | | | | |
| All Dimensions in mm | | | | | | | |

Suggested Pad Layout



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